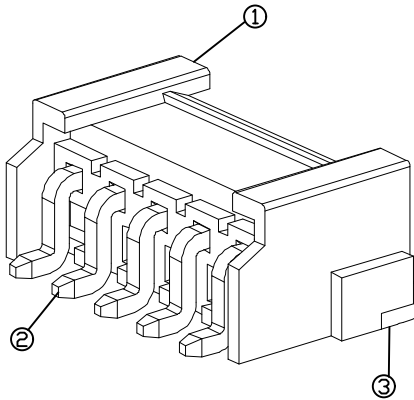
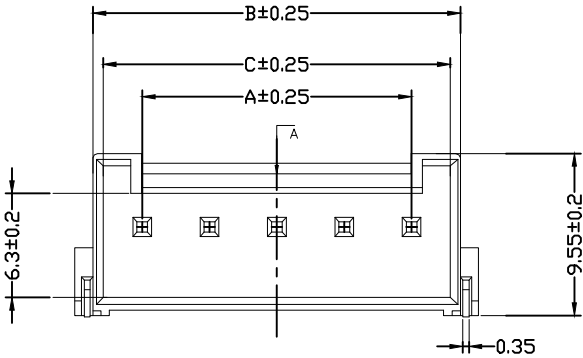
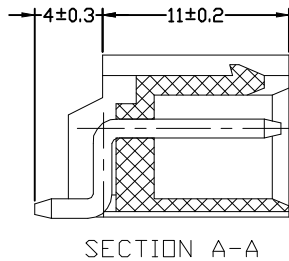
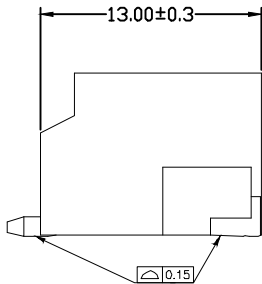
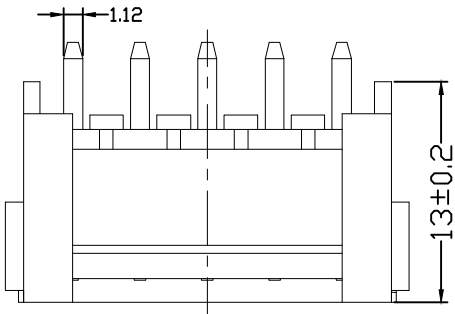


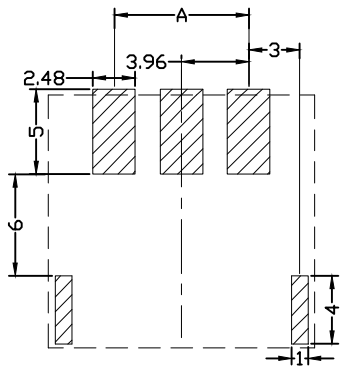
REV.	ECN NO.	LOCAS.	DESCRIPTION	DATE	DESIGN
A			NEW DRAWING		



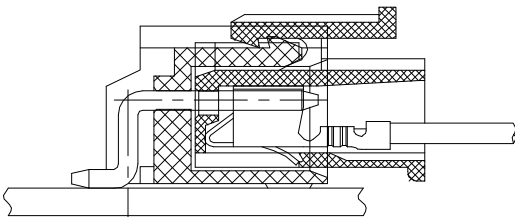
- 技术要求:
- 1、塑件材料: LCP (UL-94V-0)
 - 2、接触件: 黄铜镀锡
 - 3、接触电阻: $\leq 30m\Omega$
 - 4、绝缘电阻: $\geq 1000M\Omega$
 - 5、额定电压: 250V AC DC
 - 6、额定电流: 7.0A AC DC
 - 7、耐压: 能承受1000V AC/Minute
 - 8、工作温度: $-25^{\circ}\sim +85^{\circ}$
 - 9、可焊性试验: 浸锡面积 $\geq 95\%$ 温度260,时间 2.5 ± 0.5 秒
 - 10、铅和镉等六大有害物质含量要符合环保要求



Pin	A	B	C
2	3.96	9.8	8.6
3	7.92	13.76	12.56
4	11.88	17.72	16.52
5	15.84	21.68	20.48
6	19.8	25.64	24.44
7	23.76	29.6	28.4
8	27.72	33.56	32.36
9	31.68	37.52	36.32
10	35.64	45.44	40.28



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

3	弹片 Fitting Nail	黄铜	2	电板板: 金手指板板板30u"MIN, 厚度 80u"MIN.
2	端子 Contact	黄铜	n*1	电板板: 金手指板板板30u"MIN, 厚度 80u"MIN.
1	基板 Wafer	LCP (UL94V-0)	1	材料
序号	名称	材料	数量	附注

DESIGN:		Xiping Huang			广东国连电子有限公司								
CHECK:		Ke Tian			GUANGDONG GUOLIAN ELECTRONICS CO.,LTD								
APPROVED:		Youquan Xu		TITLE:									
DIM	TOL	DIM	TOL	3.96卧贴									
X.	±0.25			PART NO.									
X. X	±0.20			X° .	±3.0°	VH3.96-NAWB							
X. XX	±0.15			X. X°		REV. A							
X. XXX				X. XX°						SCALE: N/A			
				X. XXX°									
				SHEET: 1/1									
				 									